

# **FPN560** FPN560A



# **NPN Low Saturation Transistor**

These devices are designed for high current gain and low saturation voltage with collector currents up to 3.0 A continuous. Sourced from Process NA.

#### **Absolute Maximum Ratings\*** TA = 25°C unless otherwise noted

| Symbol                            | Parameter  | Value       | Units |  |
|-----------------------------------|--|-------------|-------|--|
| $V_{CEO}$                         | Collector-Emitter Voltage                        | 60          | V     |  |
| V <sub>CBO</sub>                  | Collector-Base Voltage                           | 80          | V     |  |
| V <sub>EBO</sub>                  | Emitter-Base Voltage                             | 5.0         | V     |  |
| Ic                                | Collector Current - Continuous                   | 3.0         | A     |  |
| T <sub>J</sub> , T <sub>stg</sub> | Operating and Storage Junction Temperature Range | -55 to +150 | °C    |  |

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### **Thermal Characteristics** TA = 25°C unless otherwise noted

| Symbol           | Characteristic                          | Max              | Units |
|------------------|---|------------------|-------|
|                  |   | FPN560 / FPN560A |       |
| P <sub>D</sub>   | Total Device Dissipation                | 1.0              | W     |
| R <sub>θJC</sub> | Thermal Resistance, Junction to Case    | 50               | °C/W  |
| $R_{\theta JA}$  | Thermal Resistance, Junction to Ambient | 125              | °C/W  |

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

# **NPN Low Saturation Transistor**

Min

(continued)

Units

Max

| Electrical Characteristics | TA = 25°C unless otherwise noted |
|----------------------------|----------------------------------|
|----------------------------|----------------------------------|

**Parameter** 

| OFF CHA           | ARACTERISTICS                          |   |     |     |    |
|-------------------|--|---|-----|-----|----|
| BV <sub>CEO</sub> | Collector-Emitter Breakdown<br>Voltage | $I_C = 10 \text{ mA}, I_B = 0$                                  | 60  |     | V  |
| BV <sub>CBO</sub> | Collector-Base Breakdown Voltage       | $I_C = 100  \mu A,  I_E = 0$                                    | 80  |     | V  |
| BV <sub>EBO</sub> | Emitter-Base Breakdown Voltage         | $I_E = 100  \mu A,  I_C = 0$                                    | 5.0 |     | V  |
| I <sub>CBO</sub>  | Collector Cutoff Current               | $V_{CB} = 30 \text{ V}, I_{E} = 0$                              |     | 100 | nA |
|                   |  | $V_{CB} = 30 \text{ V}, I_{E} = 0, T_{A} = 100^{\circ}\text{C}$ |     | 10  | μΑ |
| I <sub>EBO</sub>  | Emitter Cutoff Current                 | $V_{EB} = 4.0 \text{ V}, I_{C} = 0$                             |     | 100 | nA |

**Test Conditions** 

# ON CHARACTERISTICS\*

Symbol

| h <sub>FE</sub>      | DC Current Gain                      | $I_C$ = 100 mA, $V_{CE}$ = 2.0 V $I_C$ = 500 mA, $V_{CE}$ = 2.0 V                                  | 560<br>560A | 70<br>100<br>250 | 300<br>550        |                |
|----------------------|--------------------------------------|--|-------------|------------------|-------------------|----------------|
|                      |                                      | $I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$<br>$I_C = 2.0 \text{ A}, V_{CE} = 2.0 \text{ V}$     | 00071       | 80<br>40         |                   |                |
| V <sub>CE(sat)</sub> | Collector-Emitter Saturation Voltage | I <sub>C</sub> = 1.0 A, I <sub>B</sub> = 100 mA<br>I <sub>C</sub> = 2.0 A, I <sub>B</sub> = 200 mA | 560<br>560A |                  | 300<br>350<br>300 | mV<br>mV<br>mV |
| V <sub>BE(sat)</sub> | Base-Emitter Saturation Voltage      | $I_C = 1.0 \text{ A}, I_B = 100 \text{ mA}$  |             |                  | 1.25              | V              |
| V <sub>BE(on)</sub>  | Base-Emitter Saturation Voltage      | $I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$  |             |                  | 1.0               | V              |

# SMALL SIGNAL CHARACTERISTICS

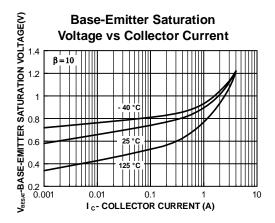
| C <sub>obo</sub> | Output Capacitance   | $V_{CB} = 10 \text{ V}, I_E = 0, f = 1.0 \text{ MHz}$           |    | 30 | pF  |
|------------------|----------------------|---|----|----|-----|
| F <sub>T</sub>   | Transition Frequency | $I_C = 100 \text{ mA}, V_{CE} = 5.0 \text{ V},$<br>f = 100  MHz | 75 |    | MHz |

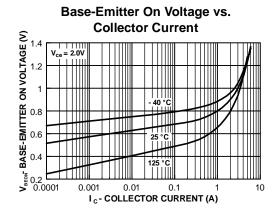
<sup>\*</sup>Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%

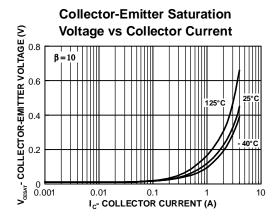
# **NPN Low Saturation Transistor**

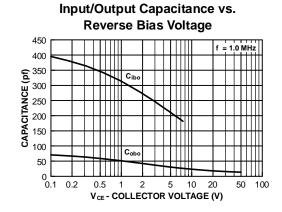
(continued)

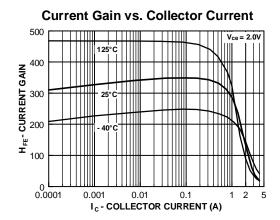
# **Typical Characteristics**

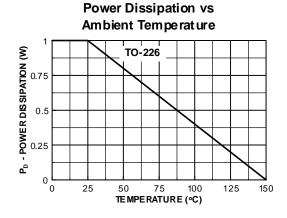












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|--------------------------|---------------------------|---|
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